

# 产品规格承认书

## SPECIFICATIONS

客户:

CUSTOMER: \_\_\_\_\_

产品名称: Bluetooth ANT

DESCRIPTION: 蓝牙天线

客户型号:

CUSTOMER PART No: \_\_\_\_\_

产品型号:

OUR MODEL NO: **PBX3216MP01**

日期:

DATE: 2020/12/22

确认签字, 盖章后请返回承认书一份


PLEASE RETURN TO US ONE COPY OF “SPECIFICATION FOR APPROVAL”

WITH YOUR APPROVED SIGNATURES

审核	刘飞	制作	刘小美
Reviewed by		Prepared by	

Shenzhen pengban Xingye Technology Co., Ltd

Room 1016, Mintai Building, Minzhi Avenue, Minzhi Street, Longhua New District, Shenzhen

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DESIGNED BY: Sera	APPROVED BY: XD		
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## PBX3216MP01 Specification

Operating Temp. : -40℃~+85℃

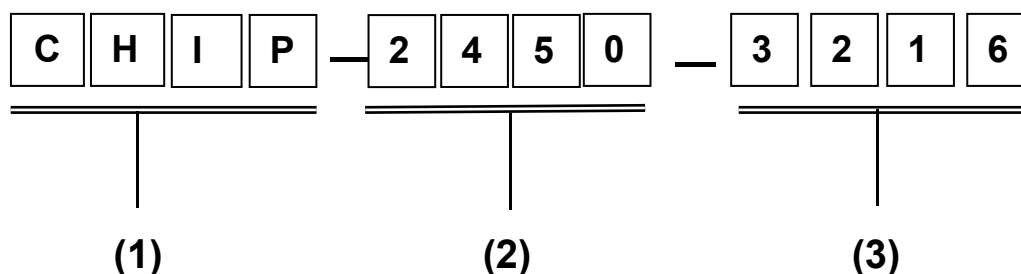
### 1. FEATURES:

- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain

### 2. APPLICATIONS:

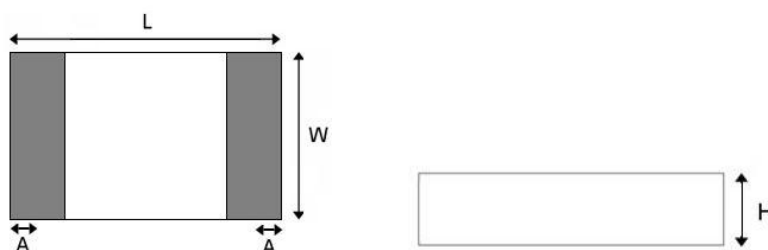
- Bluetooth, Wireless LAN, Mobile TV
- Home RF System, etc

### 3. PRODUCT IDENTIFICATION




- (1) Product type: Multilayer chip Antenna  
(2) Center Frequency: 2450MHz  
(3) External Dimensions (L×W) (mm): 3.2\*1.6

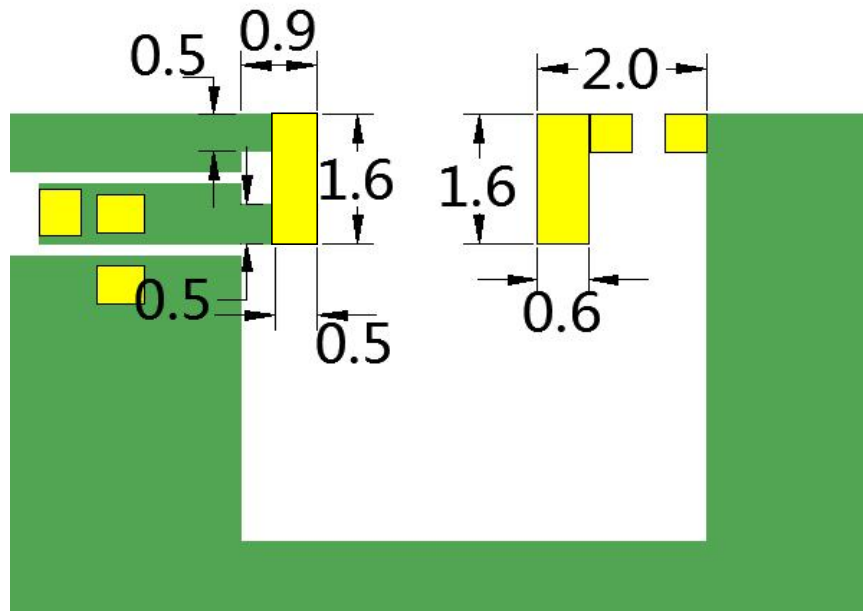
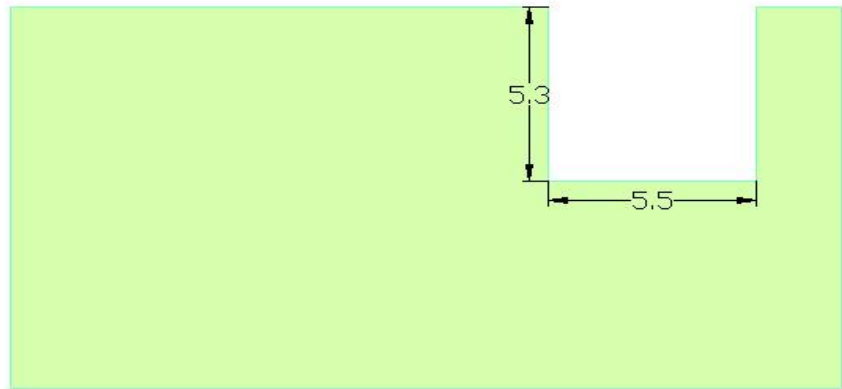
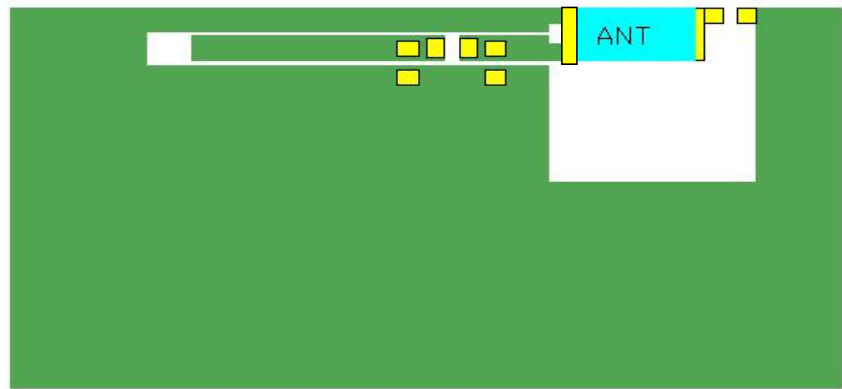
### 4. SHAPE AND DIMENSIONS:




L	W	H	A
3.2±0.2	1.6±0.2	0.52±0.1	0.4±0.1

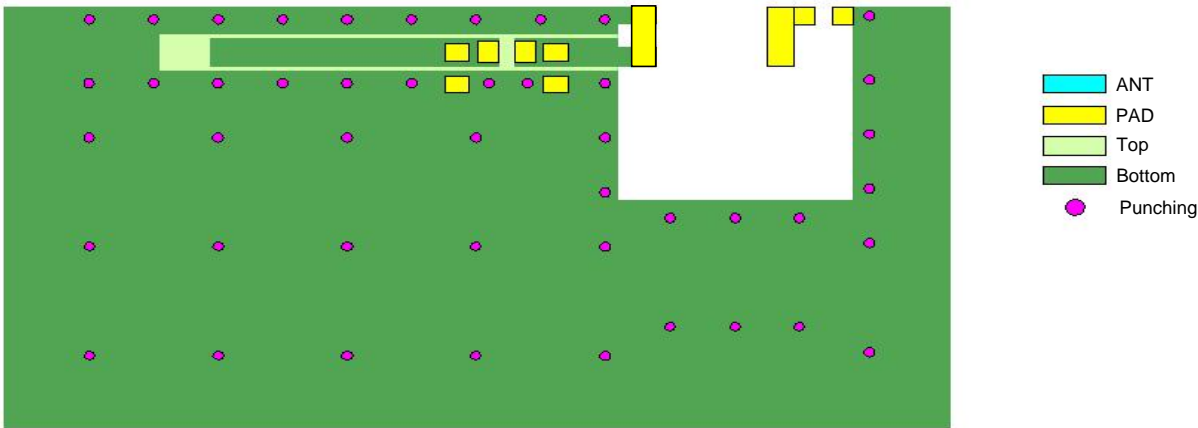
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Size(mm):

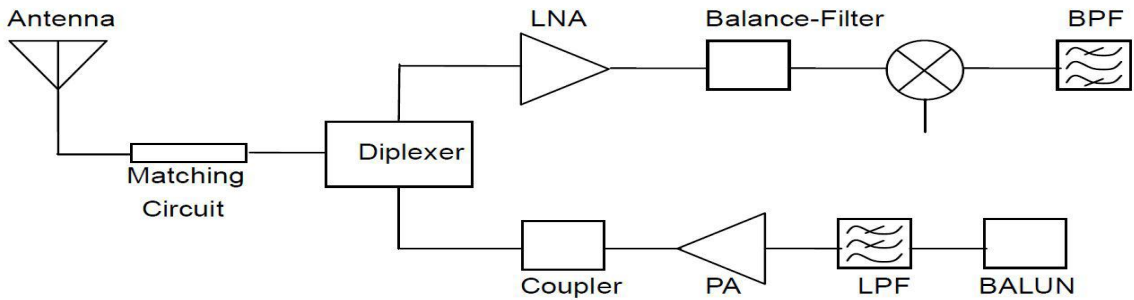


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Punching reference diagram




APPLICATION GUIDE



5. SPECIFICATIONS:

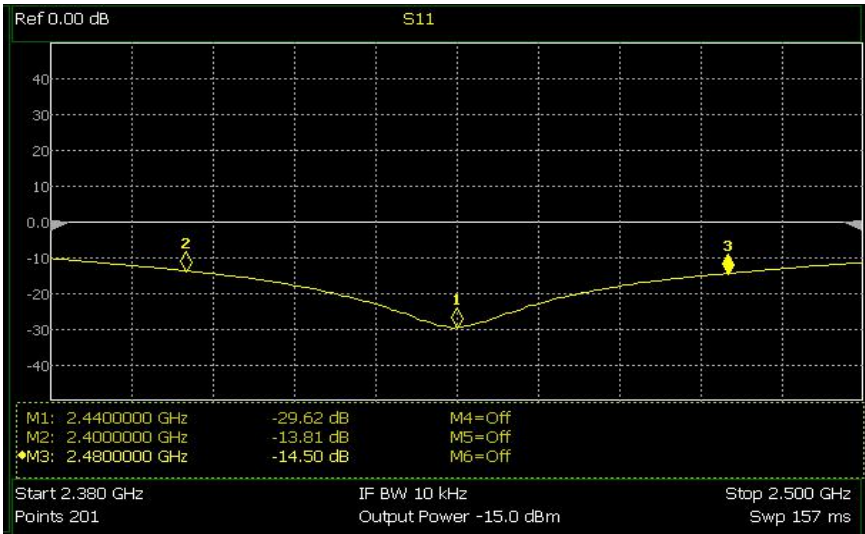
Test items	Specifications

\* Test condition: Test board size 90\*40 mm  
Matching circuit: Pi matching circuit will be required

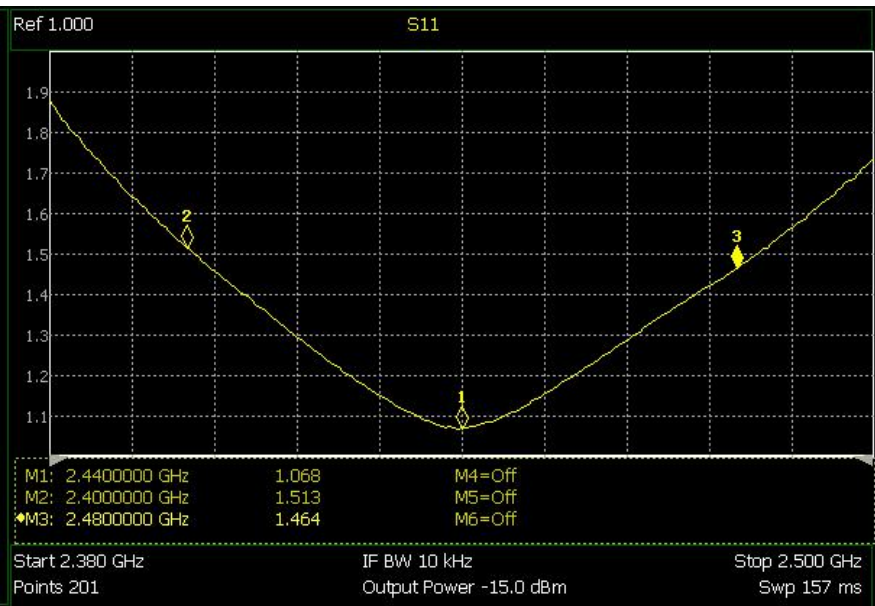
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6. Electrical Characteristics :


Loss



VSWR

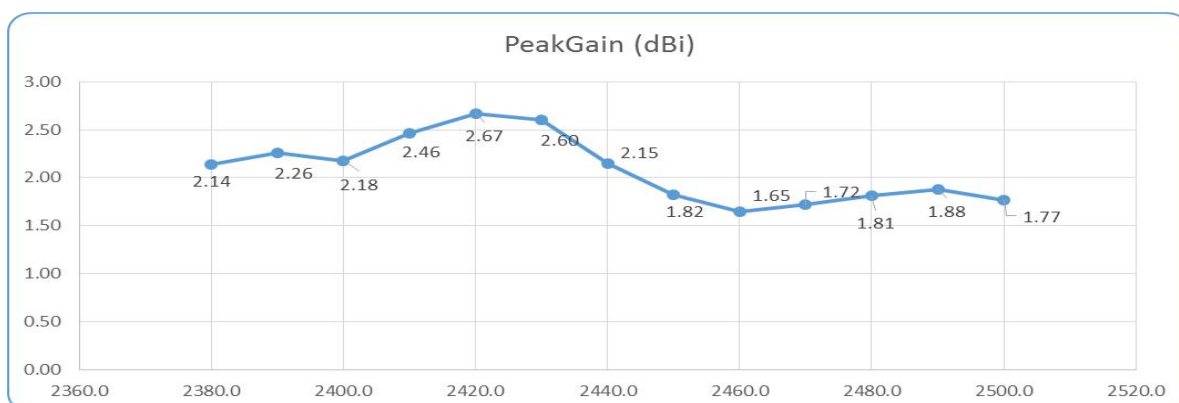
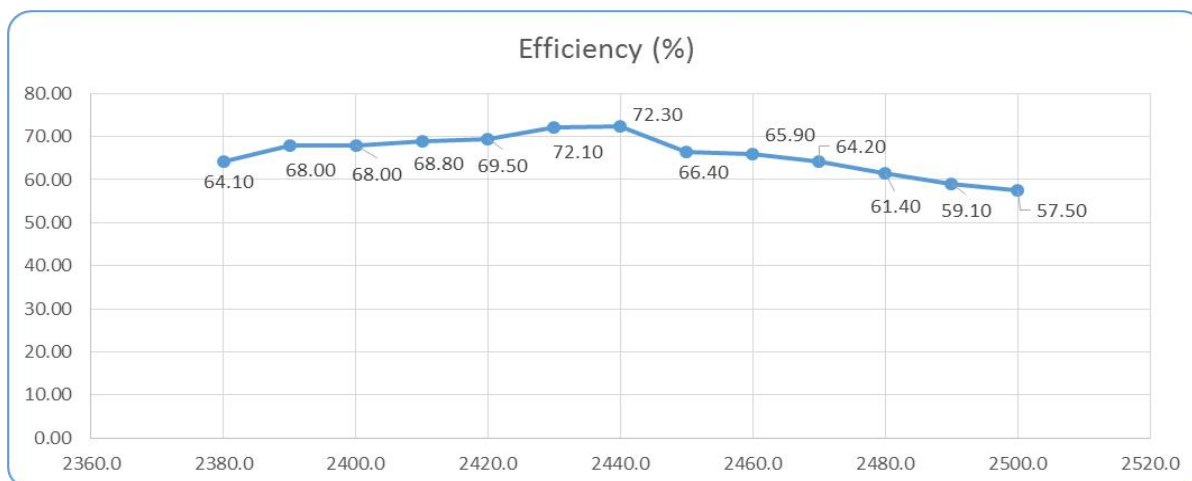
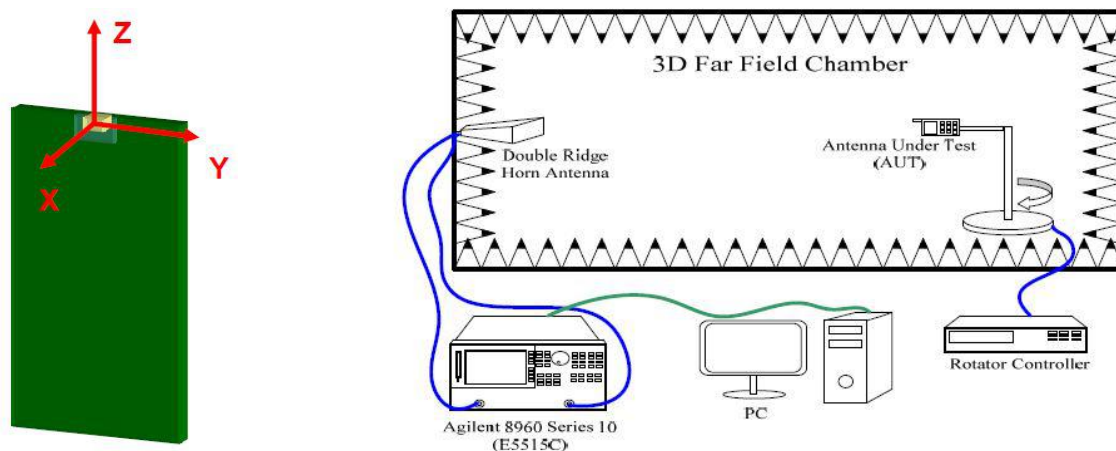


Mark	Frequency	VSWR
1	2400 MHz	1.513
2	2440 MHz	1.068
3	2480 MHz	1.464

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## Radiation Pattern

The Gain pattern is measured in FAR-field chamber. DUT is placed on the table of rotator, a standard horn antenna and Vector Network Analyzer is used to collect data.



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ANGLES = ± HOLEDIA = ±

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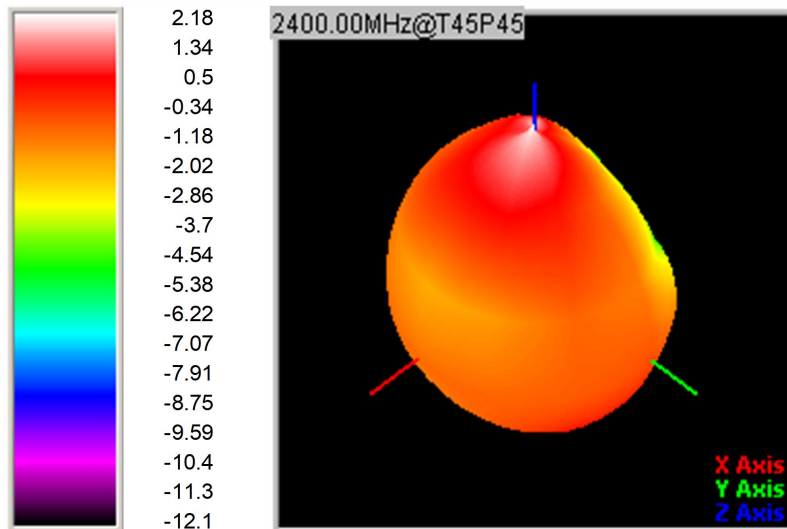
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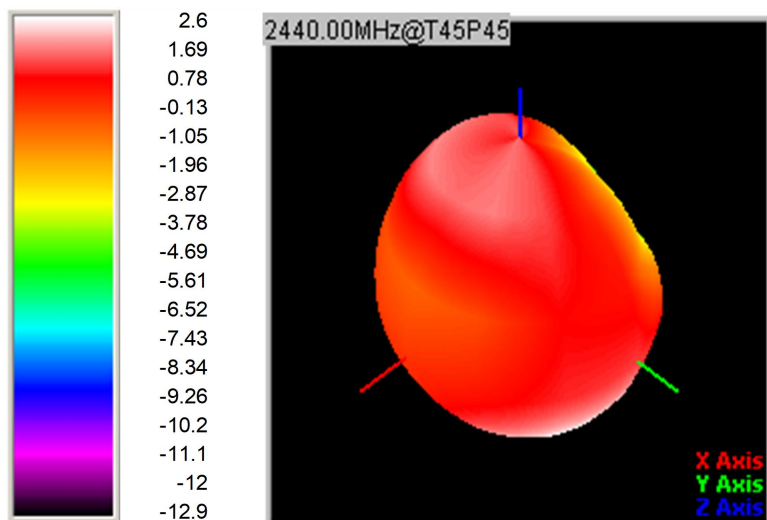
SPEC REV.

P1

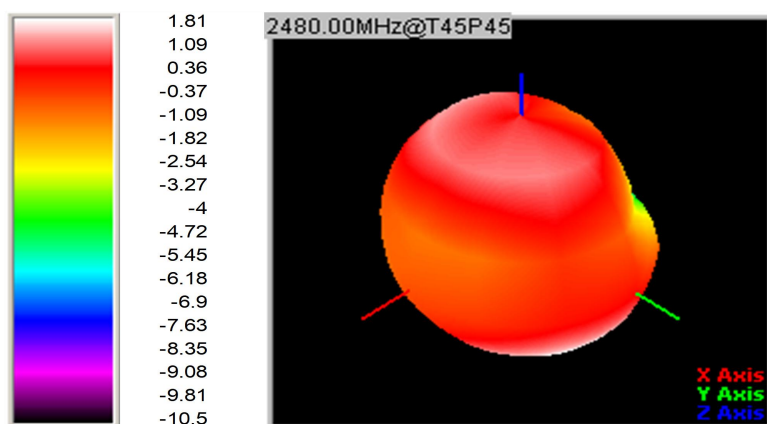
© 3D Gain Pattern (2400 MHz)



© 3D Gain Pattern (2440 MHz)



© 3D Gain Pattern (2480 MHz)



UNLESS OTHER SPECIFIED TOLERANCES ON:

X=± X.X=± X.XX=

ANGLES = ± HOLEDIA = ±

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## 7. Environmental Characteristics

### (1) Reliability Test

Item	Condition	Specification
Thermal shock	1. $30\pm 3$ minutes at $-40^{\circ}\text{C}\pm 5^{\circ}\text{C}$ , 2. Convert to $+105^{\circ}\text{C}$ (5 minutes) 3. $30\pm 3$ minutes at $+105^{\circ}\text{C}\pm 5^{\circ}\text{C}$ , 4. Convert to $-40^{\circ}\text{C}$ (5 minutes) 5. Total 100 continuous cycles	No apparent damage Fulfill the electrical spec. after test.
Humidity resistance	1. Humidity: 85% R.H. 2. Temperature: $85\pm 5^{\circ}\text{C}$ 3. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
High temperature resistance	1. Temperature: $150^{\circ}\text{C}\pm 5^{\circ}\text{C}$ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Low temperature resistance	1. Temperature: $-40^{\circ}\text{C}\pm 5^{\circ}\text{C}$ 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Soldering heat resistance	1. Solder bath temperature : $260\pm 5^{\circ}\text{C}$ 2. Bathing time: $10\pm 1$ seconds	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of $245\pm 5^{\circ}\text{C}$ for $3\pm 1$ seconds.	No apparent damage

### (2) Storage Condition

#### (a) At warehouse:

The temperature should be within  $0\sim 30^{\circ}\text{C}$  and humidity should be less than 60% RH.

The product should be used within 1 year from the time of delivery.

#### (b) On board:

The temperature should be within  $-40\sim 85^{\circ}\text{C}$  and humidity should be less than 85% RH.

### (3) Operating Temperature Range

Operating temperature range :  $-40^{\circ}\text{C}$  to  $+105^{\circ}\text{C}$ .

UNLESS OTHER SPECIFIED TOLERANCES ON:

$X=\pm$        $X.X=\pm$        $X.XX=\pm$   
**ANGLES** =  $\pm$       **HOLE DIA** =  $\pm$



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NO.

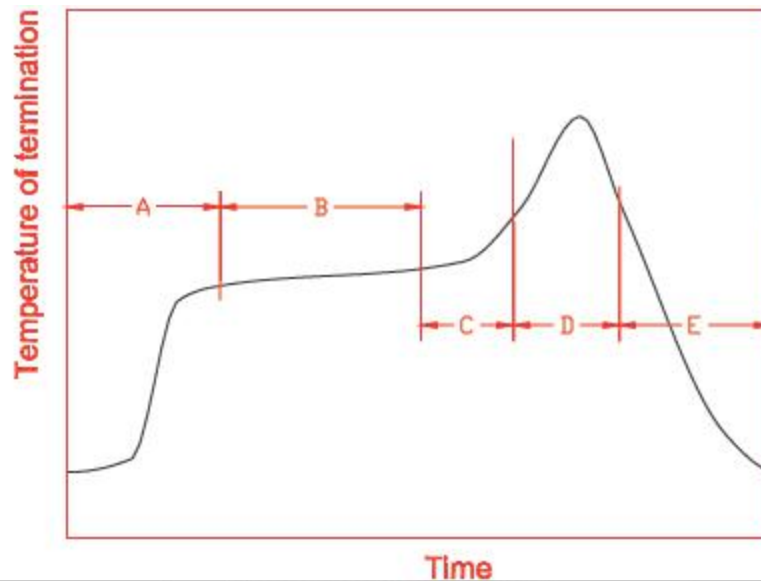
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## 8. Recommended Reflow Soldering



A	1 <sup>st</sup> rising temperature	The normal to Preheating temperature	30s to 60s
B	Preheating	140°C to 160°C	60s to 120s
C	2 <sup>nd</sup> rising temperature	Preheating to 200°C	20s to 40s
D	Main heating	if 220°C	50s~60s
		if 230°C	40s~50s
		if 240°C	30s~40s
		if 250°C	20s~40s
		if 260°C	20s~40s
E	Regular cooling	200°C to 100°C	1°C/s ~ 4°C/s

\*reference: J-STD-020C


### (1) Soldering Gun Procedure

Note the follows, in case of using solder gun for replacement.

- The tip temperature must be less than 350° C for the period within 3 seconds by using soldering gun under 30 W.
- The soldering gun tip shall not touch this product directly.

### (2) Soldering Volume

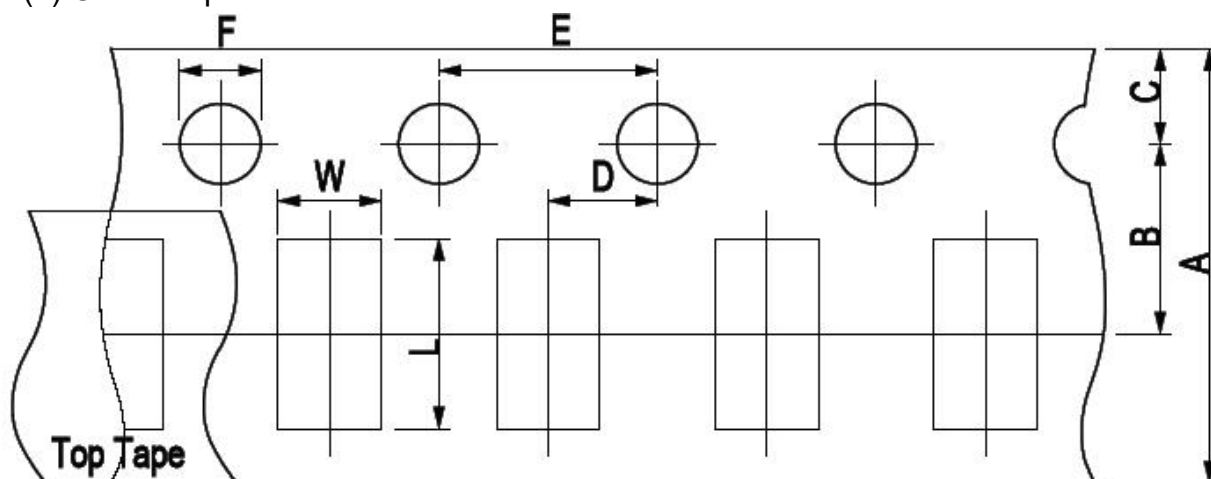
Note that excess of soldering volume will easily get crack the body of this product.

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## 9. Taping Package and Label Marking: (unit: mm)

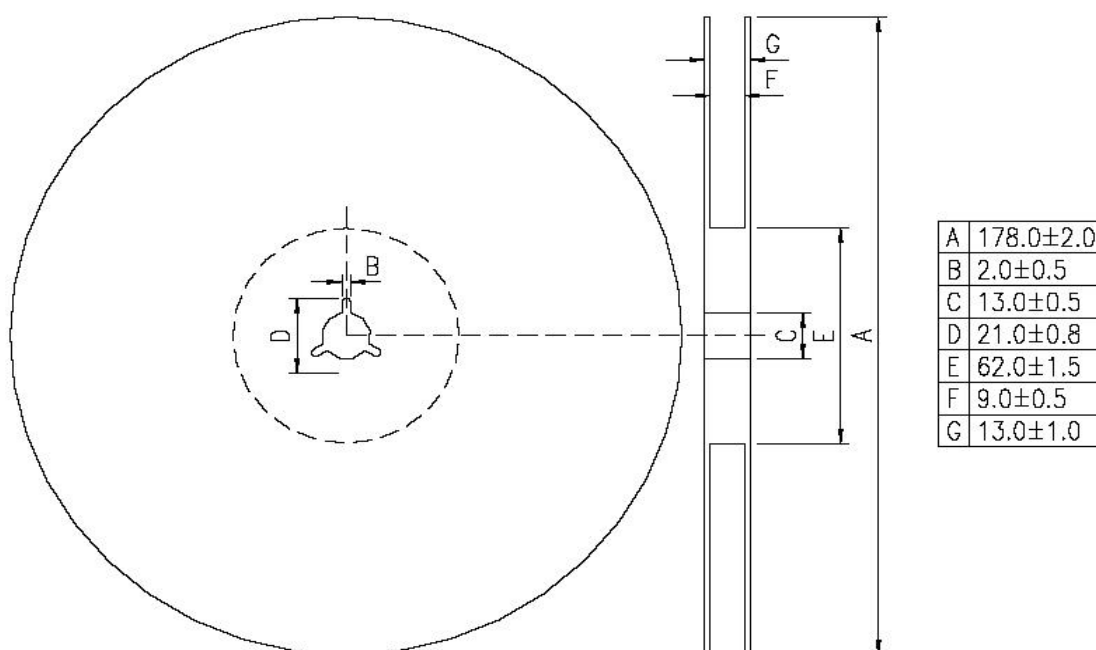
(1) Quantity/Reel: 5000pcs/Reel

(2) Carrier tape dimensions



Type	A	B	C	D	E	F	L	W
2450-21	$8.00 \pm 0.3$	$3.50 \pm 0.05$	$1.75 \pm 0.1$	$2.00 \pm 0.05$	$4.00 \pm 0.1$	$1.50 \pm 0.1$	$2.30 \pm 0.1$	$1.55 \pm 0.1$

(3) Taping reel dimensions



A	$178.0 \pm 2.0$
B	$2.0 \pm 0.5$
C	$13.0 \pm 0.5$
D	$21.0 \pm 0.8$
E	$62.0 \pm 1.5$
F	$9.0 \pm 0.5$
G	$13.0 \pm 1.0$

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$X = \pm$        $X.X = \pm$        $X.XX =$

ANGLES =  $\pm$       HOLES DIA =  $\pm$

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